SURFACE MOUNT SILICON LOW V_F SCHOTTKY RECTIFIER





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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CTLSH5-40M833S is a high performance 5.0 amp silicon Schottky rectifier designed for applications where small size and operational efficiency are prime requirements. With a maximum power dissipation of 4.5W, this leadless package design has a watts per unit area at least twice that of equivalent packaged devices.

MARKING CODE: CHA2S

FEATURES:

- High current (I_F=5.0A)
 High thermal efficiency
 3 x 3mm TLM™ case
- SYMBOL UNITS MAXIMUM RATINGS: (T_A=25°C) Continuous Reverse Voltage V_R 40 Average Forward Current 5.0 Α lO Peak Forward Surge Current (tp=8.3ms) 50 **IFSM** Power Dissipation (Note 1) P_D 4.5 W Power Dissipation (Note 2) P_{D} 4.0 W Power Dissipation (Note 3) P_D 2.5 W °C Operating and Storage Junction Temperature -65 to +150 T_J, T_{stg} Thermal Resistance (Note 1) 27.78 °C/W Θ_{JA} Thermal Resistance (Note 2) 31.25 °C/W Θ_{JA} Thermal Resistance (Note 3) 50 °C/W Θ_{JA}

$\textbf{ELECTRICAL CHARACTERISTICS:} \ (T_{\mbox{\scriptsize A}} = 25 \ ^{\circ}\mbox{C unless otherwise noted})$

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SYMBOL IR	TEST CONDITIONS V _R =20V	MIN	TYP 15	MAX 150	UNITS µA			
I _R	V _R =40V		25	200	μA			
BV_R	I _R =0.4mA	40			V			
V_{F}	I _F =1.0A		0.35		V			
V_{F}	I _F =2.0A		0.41		V			
V_{F}	I _F =3.0A		0.45		V			
V_{F}	I _F =4.0A		0.48		V			
V_{F}	I _F =5.0A		0.49	0.52	V			
C_{J}	V _R =4.0V, f=1.0MHz		220		pF			
t _{rr}	$I_F = I_R = 10$ mA, $I_{rr} = 1.0$ mA, $R_L = 100$ Ω		80		ns			

Notes: (1) Ceramic or aluminum core PC Board with copper mounting pad area of 75 mm²

(2) FR-4 Epoxy PC Board with copper mounting pad area of 75 mm²

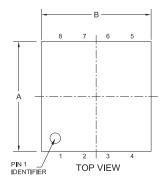
(3) FR-4 Epoxy PC Board with copper mounting pad area of 25 mm²

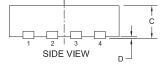
R1 (30-September 2015)

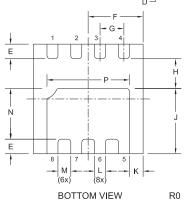
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TLM833S CASE - MECHANICAL OUTLINE







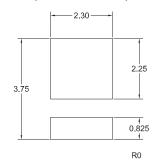
	INCHES		MILLIMETERS					
SYMBOL	MIN	MAX	MIN	MAX				
Α	0.112	0.124	2.85	3.15				
В	0.112	0.124	2.85	3.15				
С	0.031	0.039	0.80	1.00				
D	0.000	0.002	0.00	0.05				
E	0.012	0.020	0.30	0.50				
F	0.056	0.062	1.43	1.57				
G	0.026		0.65					
Н	0.030	0.033	0.75	0.85				
J	0.065	0.073	1.65	1.85				
K	0.012	0.016	0.30	0.40				
L	0.010	0.014	0.25	0.35				
M	0.012	0.016	0.30	0.40				
N	0.047	0.057	1.20	1.45				
Р	0.081	0.091	2.07	2.32				
TLM833S (REV:R0)								

DIMENSIONS

TLM833S (REV:R0)

SUGGESTED MOUNTING PADS

(Dimensions in mm)



For standard mounting see TLM833S package details

LEAD CODE:

- 1) Anode
- 2) Anode
- 3) Anode
- 4) Anode
- 5) Cathode
- 6) Cathode
- 7) Cathode
- 8) Cathode

MARKING CODE: CHA2S

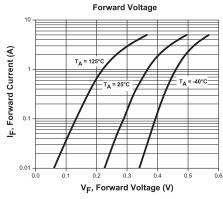
R1 (30-September 2015)

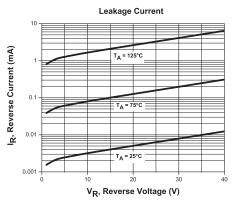
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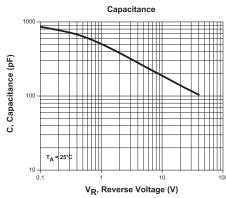
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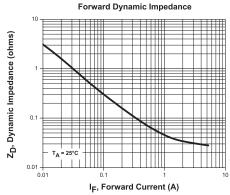


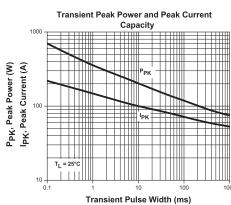
TYPICAL ELECTRICAL CHARACTERISTICS











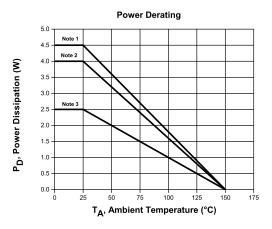
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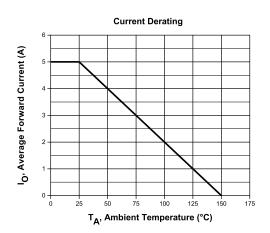
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TYPICAL ELECTRICAL CHARACTERISTICS





Notes: (1) Ceramic or aluminum core PC Board with copper mounting pad area of 75 mm² (2) FR-4 Epoxy PC Board with copper mounting pad area of 75 mm² (3) FR-4 Epoxy PC Board with copper mounting pad area of 25 mm²

R1 (30-September 2015)

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OUTSTANDING SUPPORT AND SUPERIOR SERVICES

PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- · Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- · PbSn plating options
- · Package details
- · Application notes
- Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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